PD-9.1068

IRF740LC

International IOR Rectifier

HEXFET® Power MOSEET

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement.
- Enhanced 30V Vos Rating
- Reduced Ciss, Coss, Crss.

Description

Extremely High Frequency Operation

possible using the new Low Charge MOSFETs.

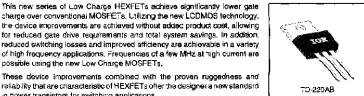
in power transistors for switching applications.

Repetitive Avalanche Rateri



$$V_{DSS} = 400V$$

 $R_{DS(on)} = 0.55\Omega$
 $I_D = 10A$



Absolute Maximum Ratings

	Parameter	Max	Units
c @ Tc ≈ 25°C	Continuous Drain Current, VGS @ 10 V	10	
lp 🕲 Tc = 100°C	Continuous Drain Current, VDB @ 10 V	6.3	A
IDM	Fulsed Drain Current @	32	
PD @ Tc = 25°C	Power Dissipation	125	W
	Linear Derating Factor	1.0	WPC
Ves	Gate-to-Source Vollage	±33	V
EAS	Single Pulse Avalanche Energy @	520	ការ
IAR .	Avalanche Current ©	10	A
EAR	Recetitive Avalanche Energy ©	13	സി
dv/dt	Peak Diode Recovery dv/dt 🔅	4.0	V/ns
TJ	Operating Junction and	-55 to +150	
Tsta	Storage Temporature Range		:C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	·
	Mounting Torque, 6-32 or M3 screw	10 lbf+in (1.1 N+m)	

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Jnits
Rac	Junction-to-Case			1.0	
Recs	Case-to-Sink, Flat, Greased Surface		0.50		CW
Rau	Junction-to-Ambient			62	·

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Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V _{(BR)OSS}	Drain-to-Source Breakdown Voltage	400	-	-	V	V _{GS} =0V, I _D = 250µA
ΔV _{IBRIDSS} /ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.76	_	v,∾c	Reference to 25°C, Ig= 1mA
Rosion	Static Dra n-to-Source On-Resistance	i —	_	0.55	Ω	VGS=10V, Ip=6.0A @
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	۷	Vps=Vgs, ip= 250LA
çıs.	Forward Transconductance	3.0	. —	_	S	Vps=50V. lp=6.0A €
1	Basia ta Gauna anata Quant			25		Vos=400V, VG3=0V
C68	Drain-to-Source Leaxage Current			250	βų	. V05=320V, VG5=0V, T,=125°C
I	Gate-to-Source Forward Leakage	· _		100		V66=20V
655	Gate-to-Source Feverse Leakage	_	-	-100	nA	V _{GS} ≖-20V
G,	Total Gate Charge		-	39	_	In=10A
C _{os}	Gate-to-Source Charge	·	-	10	nC	Vps=320V
Q.,	Gate-to-Orain (Miller) Charge		_	19		Vas=10V See Fig. 6 and 13 @
[d(m)	Turn-On Delay Time	· _	11	—		Vop=200V
ե	Rise Time	· _	31	· _	- rs	I _D =10A
(deam)	Tum-Off Delay Time	—	25			R _G =9.1Ω
tı 🛛	Fall Time	. —	20			R ₀ =20Ω See Figure 10 @
Lo	Internal Drain Inductance		4.5	· _	• nH	Between lead, 6 mm (0.25in.)
Ls	Internal Source Inductance	-	7.5	_		from package and center of die contact
Cian	Input Capacitance	.	1100			VGS=0V
Coss	Cutput Capacitance		190	_	сF	Vos= 25V
C ₇₅₅	Reverse Transfer Capacitance		18	_	-	√≂1.0MHz. See Figure 5

Source-Drain Ratings and Characteristics

	Parameter	Min	⊺ур.	Max.	Unita	i Test Conditions
ls.	Continuous Source Current (Body Diode)		_	10		MOSFET symbol
^I SM	Pulsed Source Current (Body Diode) ①	_	_	32	A	integral reverse
Vsb	Diode Forward Voltage		_	2.0	٧	T_=25°C, Is=10A, Vos=0V ④
եր	Reverse Recovery Time		380	570	rs.	T,⊨25°C, I⊫10A
Q _r	Reverse Recovery Charge	_	2.8	4.2	μĊ	dl/dt=100A/µs ⊛
tor	Forward Tum-On Time	Intrinsi	s tum-or	n time Is	neglegit	e (tum-on is dominated by Ls+Lo)

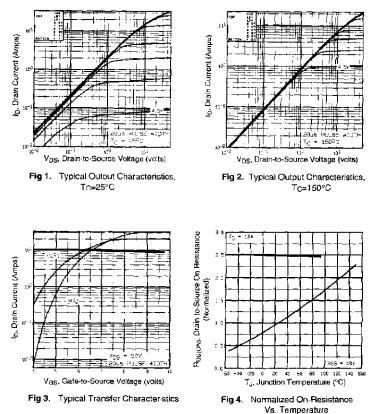
Notes:

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- C Repetitive rating; pulse width timited by max. junction temperature (See Figure 11)
- © Vod=50V, starting TJ=25°C, L=9.1mH Rg=25Ω, Ias=10A (See Figure 12)
- isos10A, dl/dls120A/µs, VodSV(8R)oss, TJS150°C
- \circledast Pulse width \leq 300 $\mu s;$ duty cycle $\leq \!\! 2\%.$

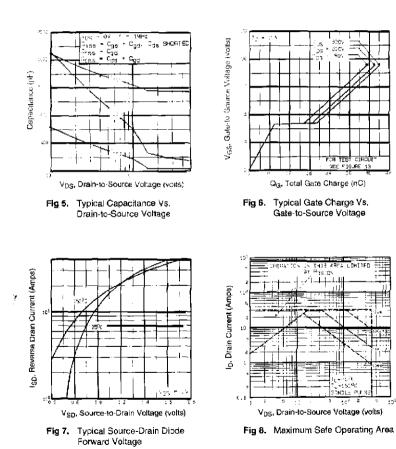
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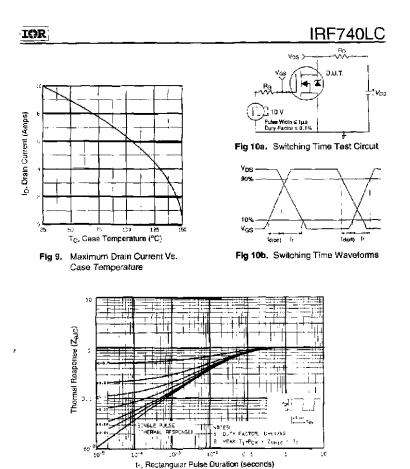


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

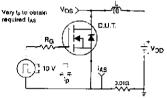


Fig 12a. Unclamped Inductive Test Circuit

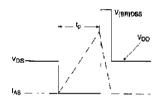


Fig 12b. Unclamped Inductive Waveforms

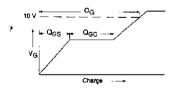
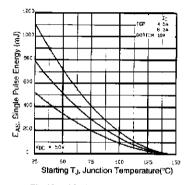
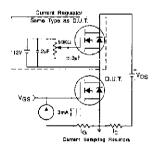


Fig 13a. Basic Gate Charge Waveform



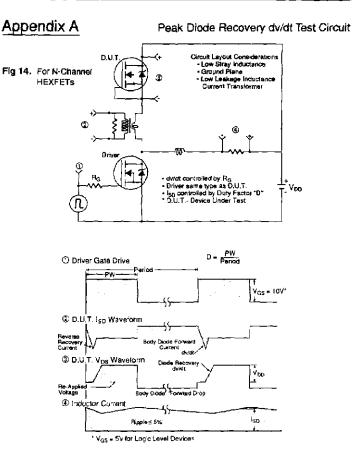
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Fig 12c. Maximum Avalanche Energy Vs. Drain Current





Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit Appendix B: Package Outline Mechanical Drawing Appendix C: Part Marking Information

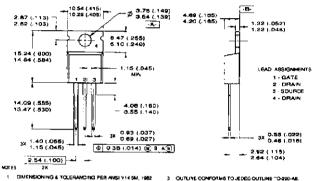


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Package Outline

TO-220AB Outline

Dimensions are shown in millimeters (inches)



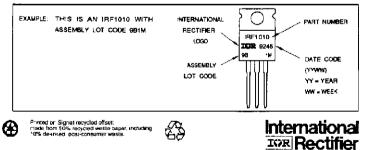
CONTROLLING & ROLEHANCING PER ANSI VIN SM, 1983
CONTROLLING DIMENSION : INCH.

OUTLINE CONFORMS TO JEDEG OUTLINE TO 220-AB.
HEATSKIK & LEAD MEASUREMENTS DO NOT MICLUDE BURRS.

Part Marking Information

Appendix C

TO-220AB



WORLD HEADOLMATERS: 233 Names St., El Segundo Cambria: 90246, Tel (310) 322-3331, Tw.: 4720403 LINOPEAN HEADOLMATERS: Head Orgen, Orget, Surrey RHS (68) England, RF: (8883) 7(325, Tel: 9829)

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Appendix B



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